

Directional Coupler

ADC-ED13116/1

Important Note

This model has been designed, built and tested in our engineering department. Performance data represents model capability. At present it is a non-catalog model. On request, we can supply a final specification sheet, part number and price/delivery information.



Please click "Back", and then click "Contact Us" for Applications support.

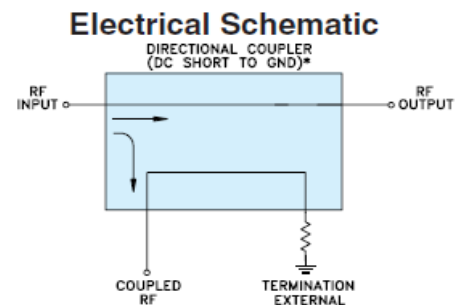
CASE STYLE : CD542

ELECTRICAL SPECIFICATIONS 75Ω @ +25°C					
Parameter		Min.	Typ.	Max.	Units
Frequency		1		1300	MHz
Coupling	Nominal		20±1		dB
	Flatness		±0.8		dB
Mainline Loss*	1-10 MHz		0.60		dB
	10-650 MHz		0.50		dB
	650-1300 MHz		0.70		dB
Directivity	1-10 MHz		25		dB
	10-650 MHz		29		dB
	650-1300 MHz		18		dB
VSWR	1-1300 MHz		1.08		(:1)
RF Power Input	1-1300 MHz			250	mW

Note: * Mainline loss includes theoretical coupled power loss of 0.044 dB at 20 dB coupling.

MAXIMUM RATINGS	
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C

PIN CONNECTIONS	
INPUT	6
OUTPUT	1
COUPLED	4
GND	2
75Ω TERM EXTERNAL	3
ISOLATE (ISOLATE)	5



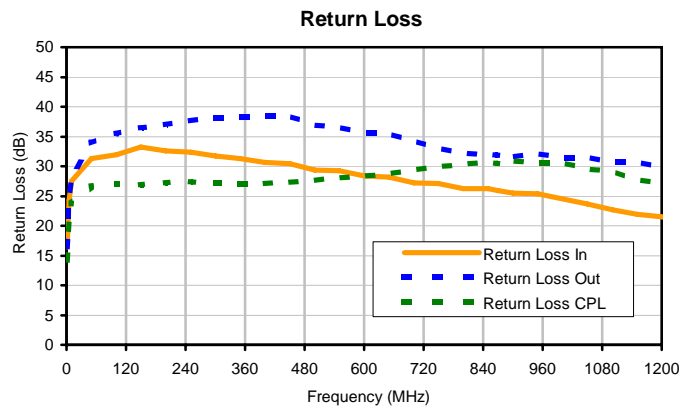
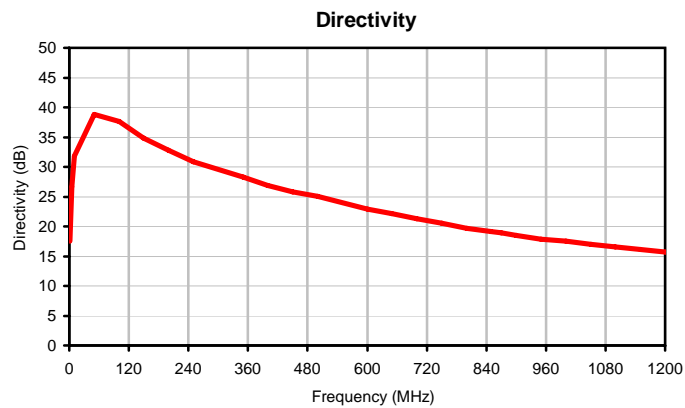
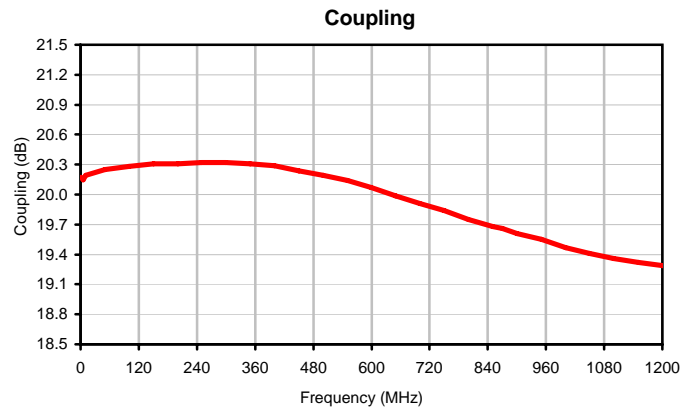
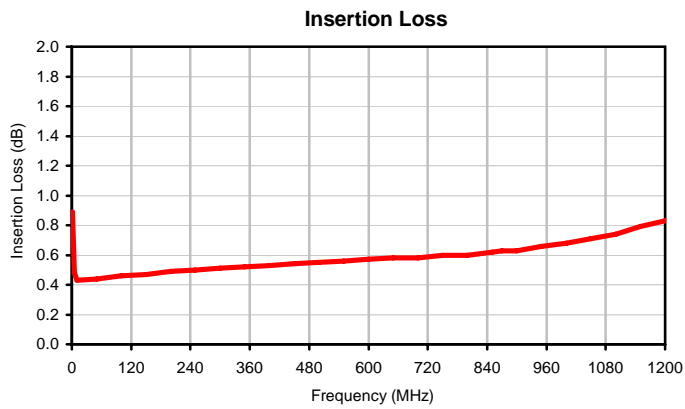
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Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	COUPLING (dB)	DIRECTIVITY (dB)	RETURN LOSS (dB)		
				IN	OUT	CPL
1.0	0.89	20.17	17.56	16.47	16.40	14.24
5.0	0.48	20.15	26.71	24.30	24.73	21.16
10.0	0.43	20.19	31.82	27.52	28.48	23.79
50.0	0.44	20.25	38.87	31.33	33.91	26.67
100.0	0.46	20.28	37.66	31.98	35.53	26.94
150.0	0.47	20.31	34.79	33.24	36.48	26.86
200.0	0.49	20.31	32.79	32.56	37.00	27.24
250.0	0.50	20.32	30.87	32.36	37.64	27.39
300.0	0.51	20.32	29.62	31.73	38.13	27.18
350.0	0.52	20.31	28.25	31.27	38.32	27.11
400.0	0.53	20.29	26.84	30.69	38.39	27.07
450.0	0.54	20.24	25.81	30.39	38.47	27.32
500.0	0.55	20.19	25.00	29.39	36.90	27.60
550.0	0.56	20.14	23.96	29.28	36.55	28.03
600.0	0.57	20.07	22.94	28.39	35.64	28.23
650.0	0.58	19.99	22.11	28.13	35.50	28.68
700.0	0.58	19.91	21.34	27.22	34.30	29.32
750.0	0.60	19.84	20.57	27.05	33.13	29.90
800.0	0.60	19.75	19.68	26.28	32.14	30.37
850.0	0.62	19.68	19.09	26.22	31.98	30.67
870.0	0.63	19.66	18.89	25.90	31.88	30.43
900.0	0.63	19.61	18.47	25.53	31.60	30.89
950.0	0.66	19.55	17.90	25.34	32.13	30.57
1000.0	0.68	19.47	17.49	24.49	31.40	30.66
1050.0	0.71	19.41	16.96	23.61	31.49	29.59
1100.0	0.74	19.36	16.56	22.68	30.77	29.14
1150.0	0.79	19.32	16.14	21.90	30.70	27.79
1200.0	0.83	19.29	15.71	21.48	29.91	27.06
1250.0	0.89	19.27	15.41	20.83	29.28	25.44
1300.0	0.94	19.24	15.08	20.56	28.18	24.51

Typical Performance Curves



Case Style

CD

CD541
CD542
CD636
CD637

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272 (6.91)	.310 (7.87)	.220 (5.58)	.100 (2.54)	.112 (2.84)	.055 (1.40)	.100 (2.54)	.030 (0.76)	.026 (0.66)	.065 (1.65)	.300 (7.62)	.20
CD636					.162 (4.11)							.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
 - For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
 - For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.

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Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
			Standard	100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

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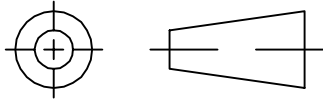
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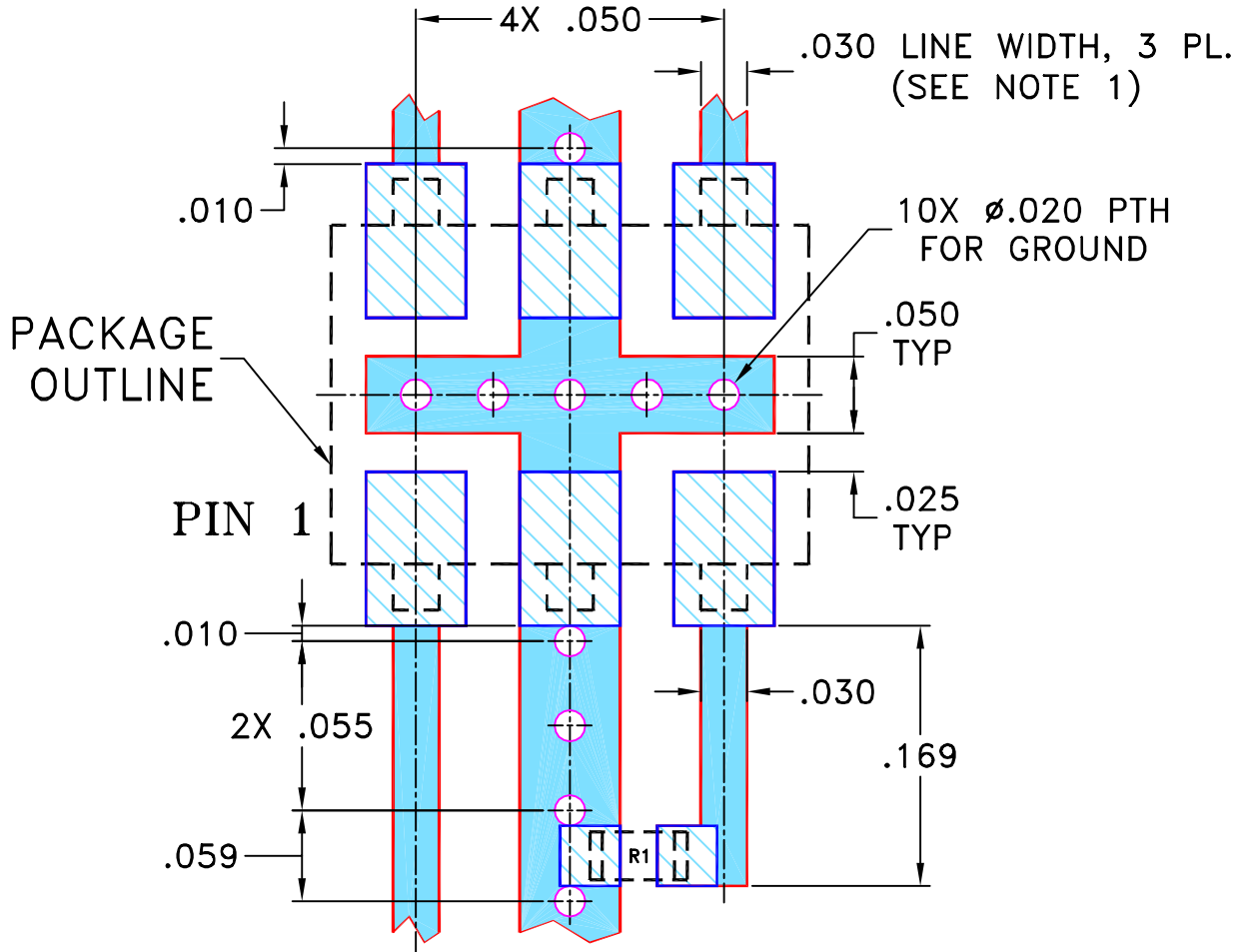
THIRD ANGLE PROJECTION



REVISIONS



REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M93216	NEW RELEASE	07/09/04	AV	WP
A	M102713	ADDED "...WITH SMOBC"	01/12/06	GF	IL

SUGGESTED MOUNTING CONFIGURATION
FOR CD636 CASE STYLE "pv" PIN CONNECTION



RESISTOR R1: 75 Ohm, 0603 SIZE

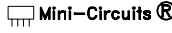
- NOTE:** 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS 0.030" ± 0.002"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
 2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

 DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS	DATE
DIMENSIONS ARE IN INCHES	DRAWN AV	07/02/04
TOLERANCES ON:	CHECKED IL	07/09/04
2 PL DECIMALS ±	APPROVED WP	07/09/04
3 PL DECIMALS ± .005		
ANGLES ±		
FRACTIONS ±		

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PL, pv, 75, CD542, ADC, TB-292

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SIZE	CODE IDENT	DRAWING NO:	REV:
A	15542	98-PL-161	A
FILE:	98PL161	SCALE:	8:1
		SHEET:	1 OF 1

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215